



ES1A - ES1G

1.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free "Green" Device (Note 3)

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.064 grams (Approximate)



Top View

Bottom View

Ordering Information (Note 4)

Part Number	Case	Packaging
ES1x-13-F	SMA	5000/Tape & Reel

* x = Device type, e.g. ES1A-13-F

Notes:

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



^{1.} EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

^{2.} See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

^{3.} Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.							
Characteristic	Symbol	ES1A	ES1B	ES1C	ES1D	ES1G	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 6)	V _{RRM} V _{RWM} V _R	50	100	150	200	400	v
RMS Reverse Voltage	V _{R(RMS)}	35	70	105	140	280	V
Average Rectified Output Current $@T_T = +110^{\circ}C$	lo			1.0			Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load				30			А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Terminal (Note 5)	R _{0JT}	25	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

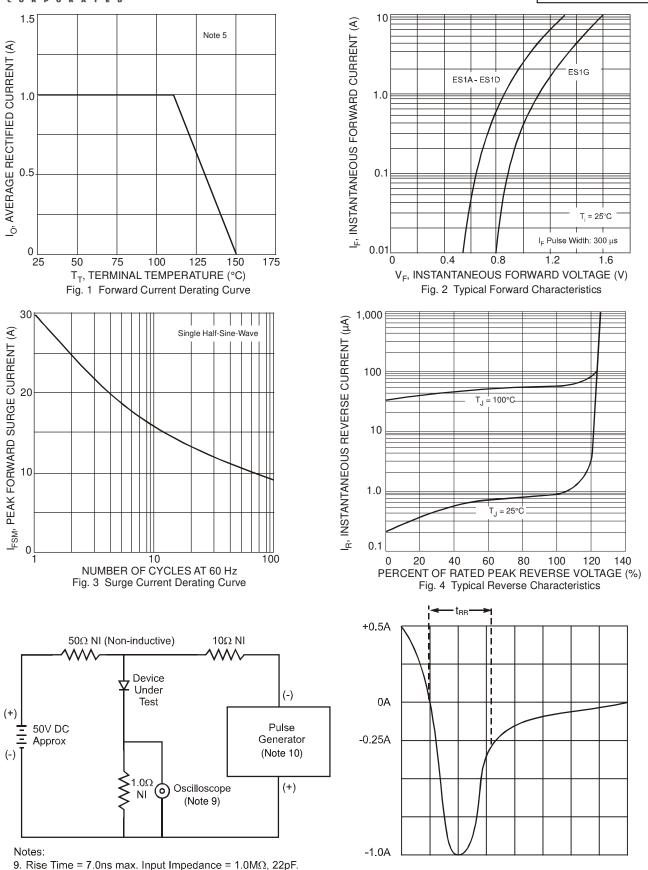
Characteristic		Symbol	ES1A	ES1B	ES1C	ES1D	ES1G	Unit
Minimum Reverse Breakdown Voltage (Note 6)	I _R = 5μΑ	V _{(BR)R}	50	100	150	200	400	V
Maximum Forward Voltage Drop	I _F = 0.6A I _F = 1.0A	V _{FM}	0.90 0.92		 1.25	V		
Peak Reverse Current at Rated DC Blocking Voltage (Note 6)	T _A = +25°C T _A = +125°C	I _{RM}	5.0 200			μA		
Maximum Reverse Recovery Time (Note 7)		t _{RR}			25			ns
Typical Total Capacitance (Note 8)		Ст			20			pF

5. Unit mounted on PC board with 5.0 \mbox{mm}^2 (0.013 mm thick) copper pad as heat sink. Notes:

6. Short duration pulse test used to minimize self-heating effect.

7. Measured with I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A. See figure 5. 8. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.





10. Rise Time = 10ns max. Input Impedance = 1.0002, 22

Set time base for 50/100 ns/cm

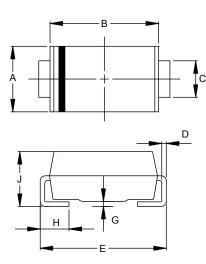
Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

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Package Outline Dimensions

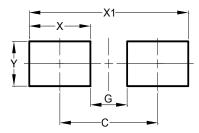
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SMA					
Dim	Min	Max			
Α	2.29	2.92			
В	4.00	4.60			
С	1.27	1.63			
D	0.15	0.31			
E	4.80	5.59			
G	0.05	0.20			
Н	0.76	1.52			
J	1.96	2.40			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70



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